



05PM

2827

PATENT APPLICATION
Do. No. 9898-206

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Shin KIM, et al.

Serial No. 10/068,628

Examiner: Dinh, Tuan T

Confirmation No. 6784

Filed: February 6, 2002

Group Art Unit: 2827

For: SEMICONDUCTOR DEVICE BONDING PAD RESISTANT TO STRESS
AND METHOD OF FABRICATING THE SAMEBOX NON FEE AMENDMENT
Assistant Commissioner for Patents,
Washington, D.C. 20231Responsive to the Office Action dated August 14, 2002, enclosed is an amendment in the
above-identified application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	16	20	0	x \$18 =	\$0
Independent Claims	2	3	0	x \$84 =	\$0
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0

*greater of twenty (20) or number for which fee has been paid

**greater of three (3) or number for which fee has been paid


Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.



20575

PATENT TRADEMARK OFFICE


Alan T. McCollom
Reg. No. 28,881MARGER JOHNSON & McCOLLOM, P.C.
1030 SW Morrison Street
Portland, OR 97205
(503) 222-3613I HEREBY CERTIFY THAT THIS COR-
RESPONDENCE IS BEING DEPOSITED
WITH THE UNITED STATES POSTAL
SERVICE AS FIRST CLASS MAIL IN AN
ENVELOPE ADDRESSED TO:
☐ COMMISSIONER OF PATENTS AND
TRADEMARKS, WASHINGTON D.C.
20231
☒ ASSISTANT COMMISSIONER FOR
PATENTS, WASHINGTON D.C. 20231
☐ ASSISTANT COMMISSIONER FOR
TRADEMARKS, 2900 CRYSTAL DRIVE,
ARLINGTON VA 22202-3513
ON 11-12-02